A Thin-film Magnetoresistive Angle Detector

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Abstract

An overview is given of the results of our research on a contactless angle detector based on the anisotropic magnetoresistance effect (AMR effect) in a permalloy thin film. The results of high-temperature annealing treatment of the permalloy film are discussed. Such a treatment suppresses the effects of the uniaxial magnetic anisotropy that is present in a permalloy thin film and increases the AMR effect, thus improving the detector signal. The performance of the detector throughout a temperature range of 20 to 120 °C and the results of heat treatment at 125 °C for 1 week have been tested.

Introduction

Over the past 5 years, a contactless angle detector based on the anisotropic magnetoresistance effect (AMR effect) in a permalloy thin film has been proposed and developed [1, 2]. This paper presents an overview of the results of our research on this detector and discloses recent unpublished results.

The angle detector consists of a pair of identical pseudo-Hall devices (PHDs), or equivalent devices such as magnetoresistor bridges, mutually rotated through 45° and positioned opposite a rotatable permanent magnet. The magnetic field at the position of the PHDs is largely in-plane (Fig 1). The magnetization angle θ in the PHDs reflects the angular position φ of the rotatable magnet and is comprised in the output signals of the PHDs:

\[ V_1 = I \Delta \rho \sin(2\theta) \]
\[ V_2 = I \Delta \rho \cos(2\theta) \]

in which \( I \) is the driving current of the PHDs and \( k \) is a geometrical factor. The output angle of the detector, \( \Theta \), is independent of temperature, in principle. The magnetoresistivity \( \Delta \rho \) and resistivity \( \rho \) of the permalloy are defined as

\[ \Delta \rho = (\rho_\parallel - \rho_\perp) / 2 \] and \[ \rho = (\rho_\parallel + \rho_\perp / 2) \]

in which \( \rho_\parallel \) and \( \rho_\perp \) are the resistivity parallel and perpendicular to the magnetization in the permalloy. The permalloy thin films are sputtered in the magnetostiction-free composition (81 at % Ni and 19 at % Fe). This ensures a low influence of temperature-induced or mechanically-induced stresses in the film. The values of \( \Delta \rho \) and \( \rho \) are 3 × 10⁻⁹ Ωm and 2 × 10⁻⁹ Ωm in a fresh film.

The performance of an angle detector as described above depends on its magnetic and electrical properties. The magnetic properties of the detector include the strength and homogeneity of the magnetic field of the magnet, on the one hand, and the magnetic properties of the permalloy thin film on the other. The electrical properties of the detector, which have been discussed elsewhere [3], are determined by the magnetoresistive properties of the permalloy and the geometry of the PHDs. Of course, the stability of all these properties is of major importance for the performance of the detector. The electrical and magnetic properties of the system can be treated separately, because their mutual interaction (normal Hall effect, magnetic fields caused by the currents in the thin film etc.) is negligible.

Magnetic Behavior

A few short remarks concerning the permanent magnet should be made. The magnetic field at the...
position of the PHDs should be large to ensure a small influence of the earth's magnetic field and other disturbing AC or DC fields, the field should be stable (no demagnetization) and it should be homogeneous to enable a homogeneous magnetization of the PHDs. These requirements can be met using common magnetic materials like anisotropic ferromagnets. In practical situations, errors caused by disturbing magnetic fields (e.g., the earth's magnetic field) or by the inhomogeneity of the field can be kept below 0.1° [1]. If very large field strengths and high stability of the magnet are required, new magnetic materials like SmCo5 and NdFeB can be applied.

Permalloy films show magnetic anisotropy, which causes an orientation difference between the magnetization and the magnetic field, resulting in an angle detector measurement error. The magnetic anisotropy can be oriented if the film is deposited in the presence of a magnetic field [4]. Under normal deposition conditions, the anisotropy field strength \( H_k \) in a sputtered or evaporated film is about 350 A/m, leading to a maximum angle detector measurement error of about 0.5° if a magnetic field of 20 kA/m is used. In many cases this error is not acceptable. A number of techniques have been developed to reduce this error [1]. The use of a permalloy bilayer with perpendicular in-plane orientation of the anisotropy in both sublayers proved to be very successful. The results have been published elsewhere [5].

Alternatively, one can use a permalloy film consisting of many small areas with randomly oriented magnetic anisotropy. If such a film experiences a sufficiently large in-plane magnetic field (larger than the local anisotropy field \( H_k \)) with arbitrary orientation, the mean magnetization in the film will have the orientation of the field [1]. To manufacture such a magnetically isotropic film, deposition of the permalloy in a rotating magnetic field was considered [6]. This technique was not successful. We discovered in several experiments that a permalloy layer with a well-defined anisotropy dictates the anisotropy orientation of a second layer sputtered on top of the first, even in a moderate (2 kA/m) in-plane magnetic field of arbitrary but constant orientation. This indicates that the orientation of the anisotropy is transferred to the second layer by means of some nonmagnetic interaction (e.g., by the surface structure of the first film) or that the magnetic anisotropy is confined to and transferred by certain (small) areas in the film which are not influenced at the field strength used. The fact that Goto et al. [7] managed to reorient the anisotropy in the second layer using a stronger deposition field indicates that the latter is valid or that a balance exists between field-induced and structure-induced anisotropy.

Another method to produce a magnetically isotropic permalloy film is the use of a high-temperature annealing step to disorder the anisotropy locally inside the permalloy layer. Experiments performed by Metzdorf [8] show that changes in anisotropy orientation, induced by annealing in a magnetic field at temperatures up to 400 °C, are partly reversible when annealing at lower temperatures. Stable films are obtained after annealing at temperatures above 400 °C [4]. In our case, a desorientation of the magnetization in the permalloy is necessary during annealing. This can be achieved by exceeding the Curie temperature (for permalloy at a 81/19 composition, just above 500 °C). We annealed a number of films at different temperatures between 200 °C to 600 °C for 1 h and measured the coercivity \( H_c \) of the film (using an inductive hysteresis loop tracer), \( \alpha_{90} \) (the angle which includes 90% of all anisotropy orientations in the film, measured using the Crowther method [9]), and the maximum angle between the magnetic field and the mean magnetization in the \((\varphi - \Theta)_{\text{max}}\), at a field strength of 2 kA/m using

![Fig 2](image-url)
the measurement system described in ref 10. The films were annealed in a nitrogen atmosphere and were protected by a 75-nm SiO film. The results are shown in Fig 2(a) and (b). It is clear that $\alpha_{so}$ increases with increasing annealing temperature, as expected. The films annealed at 600 °C are magnetically isotropic. In these films, $\alpha_{so}$ cannot be determined with the Crowther method.

To gain more insight into the properties of the annealed films, we performed computer simulations of films consisting of a large number of small areas with no mutual magnetic interaction, each having a well-defined magnetic anisotropy ($H_k$ equal to that of a fresh film, 350 A/m), with an orientation distribution as measured in our annealed films. The calculated values of $(\varphi - \Theta)_{max}$ at a field strength of 2 kA/m are shown in Fig 2(b). Two possible mechanisms can cause the observed differences:

- The anisotropy field strength of small areas with well-defined anisotropy decreases during annealing.
- A large fraction of the total amount of these areas has random anisotropy orientation. This fraction is not visible in measurements of $(\varphi - \Theta)_{max}$ or in the Crowther measurements, but it reduces the influence of the remaining part of the film on the orientation of the mean magnetization.

The areas with well-defined anisotropy orientation in high-temperature ($\geq 500$ °C) annealed films are small. In Kerr rotation measurements using a small light spot of a few tens of micrometers, comparable magnetic behavior in different areas is found.

Deterioration of the permalloy in high-temperature annealed films could be responsible for the observed increase in coercivity. Capacitor structures of $100 \times 100 \mu$m formed by a permalloy film, a 75-nm SiO layer and an aluminum layer showed low resistance in some cases, but good isolation in some other cases, all on the same wafer. This indicates that the SiO layer is not completely closed (e.g., due to pin-holes). No visible damage to the film surface could be found with microscopic inspection and SEM.

It is concluded that a film annealed at 500 °C for 1 h is appropriate for use in an angle detector ($\Delta H = 20$ kA/m). High-temperature annealing has another advantage: it lowers the resistivity of the film [11], thus increasing the magnetoresistivity ratio $\Delta \rho / \rho$ from 1.5% in fresh films to 2%.

Technology

The manufacture of our PHDs and magnetoresistor bridges is straightforward. A permalloy film is deposited by RF sputtering on an oxidized silicon wafer. The film geometry is produced using photolithographic techniques and wet chemical etching. Film and substrate are covered with a 75-nm SiO film. The wafer is annealed for 2 h at 500 °C and a stable, magnetically isotropic film is obtained. Via-holes are etched in the SiO layer by reactive-ion etching in a CF$_4$/O$_2$ atmosphere. The permalloy is back-sputtered to provide a clean surface for the contacts. Stable contacts with low interdiffusion at high temperatures can be produced using Mo and Cr as a contact material [12]. We use a 25-nm chromium film followed by a 0.5-μm aluminum layer. The aluminum and chromium are wet-etched using the same photoresist mask. The wafer is sliced and the devices are mounted on a substrate.

Stability

The stability of the electrical and magnetic properties of the devices can be determined in two ways. In order to determine the behavior of the devices at different temperatures from 20 °C to 120 °C, the devices were mounted on a heating plate in an angle detector set-up [10]. Alternatively, the devices were heated to 125 °C and their properties measured after 1, 2, and 7 days. All measurements were performed on PHDs of $3 \times 3$ and $1 \times 1$ mm.

Concerning the magnetic anisotropy in the films, it could be concluded that small anisotropy could be induced by annealing at 125 °C in a magnetic field. The resulting values of $(\varphi - \Theta)_{max}$ in different films in a field of 20 kA/m were determined to be well below 0.1° for all films.

Devices with a large overlap of the contact material over the SiO-covered permalloy showed large, irreversible changes in signal amplitude and offset during heat treatment, presumably due to the fact that the SiO layer was not completely closed. The following results concern devices with a small overlap which showed good stability.

Amplitude imbalance between two as-manufactured devices in an angle detector is usually of the order of 1–5%. Temperature-induced imbalance in the temperature range of 20 to 120 °C shows a maximum of 0.5%, yielding a measurement error of less than 0.1°.

Offset stability in the devices is very critical, because of the sensitivity of the offset voltage to geometrical variations. The offset was trimmed to zero at 20 °C using the correction circuit shown in Fig 3. In subsequent measurements, the trimmed devices showed an offset of less than 1% in the temperature range 20 °C to 120 °C. The offset changes are reversible and are attributed to position-dependent changes in the properties of
the contacts. The changes in offset after annealing at 125 °C for longer times are generally lower than 0.75%. We can conclude that offset attributes less than 1.75% to the signal under normal conditions in the temperature range 20 °C to 120 °C, leading to angle detector measurement errors of 0.5° maximum.

It is concluded that the offset stability is the limiting property with regard to the accuracy of the angle detector. Further research will focus on this problem.

Conclusions

With the techniques described above, angle detectors with an accuracy of 0.5° over a temperature range of 20 to 120 °C can be produced. There is no indication that the temperature range cannot be extended to lower temperatures. The accuracy is mainly limited by temperature-induced changes in the offset of the devices. If the technology can be adapted to provide more stable contacts, an accuracy of 0.2 to 0.1° should be attainable.

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References